



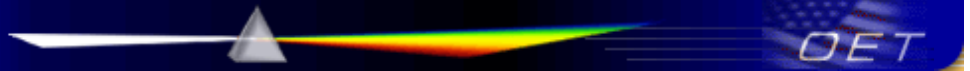
Joseph Brunett <jdbrunett@gmail.com>

Response to Inquiry to FCC (Tracking Number 280186)

oetech@fccsun27w.fcc.gov <oetech@fccsun27w.fcc.gov>

Mon, Nov 17, 2008 at 4:48 PM

To: jdbrunett@gmail.com

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Office of Engineering and Technology

Inquiry:

---Reply from Customer on 11/08/2008---

I have just been informed by my TCB that their PBA request for the same devices does not match with this response. They are asking that, per Inquiry 751504, I provide a detailed explanation of how the devices are potted, what the potting material is, how its removal destroys the pcb, and leave me with the impression that a PBA may be needed for every application. Please note that the chemical makeup of the potting material may in itself need to remain confidential as it is proprietary in this industry (not many materials can handle 30g's). Please correspond with the reviewer of KDB Inquiry 751504, relay that internal photographs provided without potting are not obtained by "removing" the potting material, but are "pre-potted" photos, and provide both inquiries with a single, consistent, request for more information if needed. Please indicate if additional PBA requests will be required for every like application. I apologize if the tone of this response seems harsh, I do not mean it to be. However, every delay caused by inconsistent responses requires that I call my clients, outline the problem, request additional information, and request their patience. The current climate in the auto industry makes the final request more challenging as of late. ;) JDB

Response:

You should not need a PBA request for every filing since you may reference this KDB in each subsequent filing for similar device.

Do not reply to this message. Please select the [Reply to an Inquiry Response](#) link from the OET Inquiry System to add any additional information pertaining to this inquiry.
